



RFM Integrated Device, Inc.

PRODUCT SPECIFICATION

Part Number: XO6007

XO,133 MHz, +/-30 ppm max,
-40°C to +85°C

SMD 2.5x2.0 133MHz Crystal Oscillator



Features:

- Surface Mount Seam Weld Package
- Excellent Reliability Performance
- Excellent Frequency Perturbation and Stability over temperature
- Moisture Sensitivity Level (MSL) : Level-1

Application:

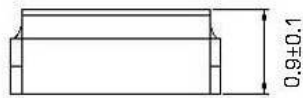
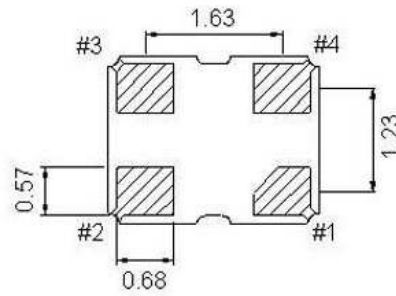
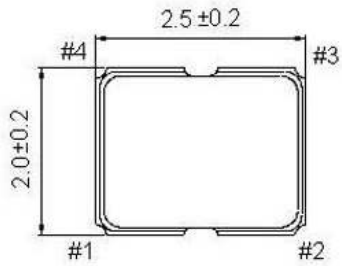
- Supply Voltage CMOS Output
- Option-able stand-by functions for output.

Electrical Characteristics:

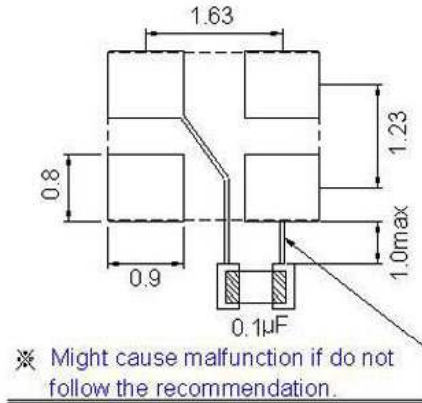
XO6007	Specifications
Nominal Frequency, Fo	133.000000MHz
Storage Temperature Range	-55°C to +125°C
Operating Temperature Range	-40°C to +85°C
Power Supply Voltage, Vcc	3.3V +/- 5%
Load	15pF
“0” Level “1” Level	Vol: 10%Vcc max Voh:90%Vcc min
Frequency Stability ¹	+/-30 ppm max
Duty Cycle	45% ~ 55%
Power Supply Current, Icc	22 mA max
Rise Time (10% -> 90% of final RF level in Vp-p) Fall Time (90% -> 10% of final RF level in Vp-p)	2.0 nsec max.
Start Time	2.0 msec max
Aging	3.0 ppm/year
Unit Weight	14 +/-0.5mg
Enable/Disable Function	PIN 1: Vih:70%Vcc min or Open, PIN 3: Output Enable PIN 1: Vil:30%Vcc max, PIN 3:Output Disable

#Note 1: Frequency accuracy includes 25C tolerance, operating temperature range -40 to 85 deg C, first year of aging and voltage or load change

Mechanical Dimensions: (Unit: mm)

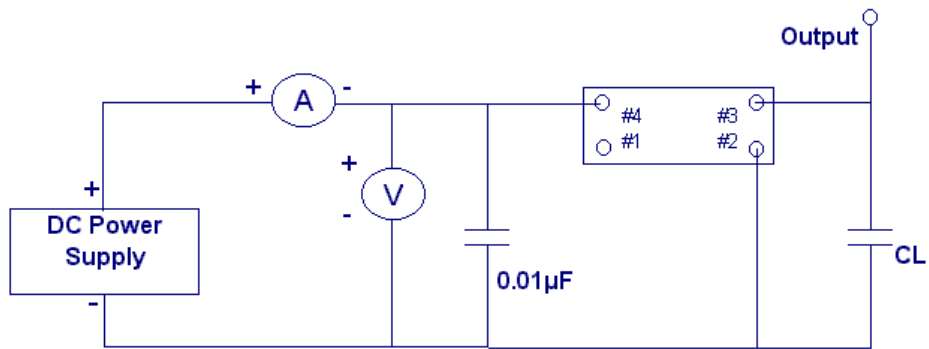


Pin	Function
#1	Tri-State
#2	GND
#3	Output
#4	V _{DD}

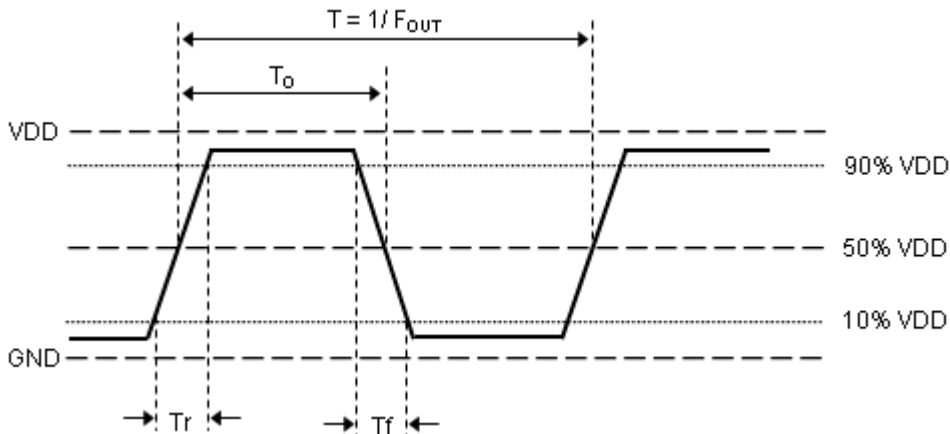


Recommended soldering pattern

Test Circuit:



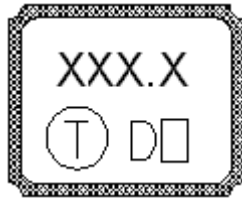
Output Waveform :



Marking:

Line 1: Frequency(133.0)

Line 2: Date Code + Product Code(□ is manufacturer's internal tracking code, could be a~z and A~Z)



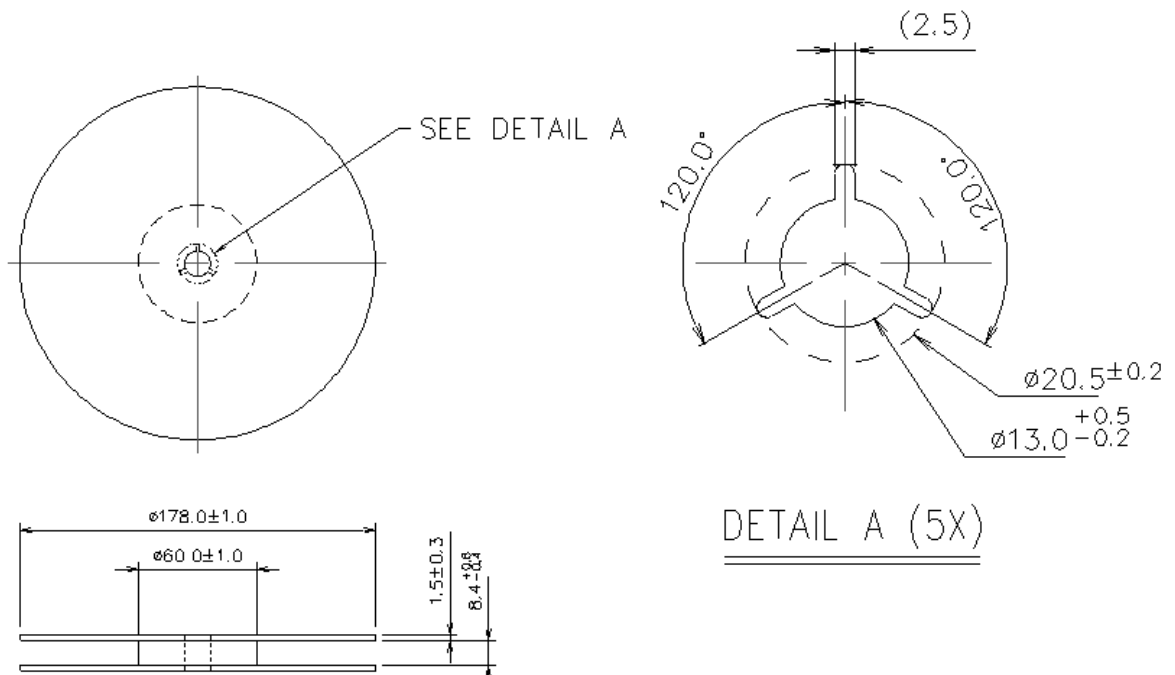
Date Code Table

WK01	WK02	WK03	WK04	WK05	WK06	WK07	WK08	WK09	WK10	WK11	WK12	WK13
A	B	C	D	E	F	G	H	I	J	K	L	M
WK14	WK15	WK16	WK17	WK18	WK19	WK20	WK21	WK22	WK23	WK24	WK25	WK26
N	O	P	Q	R	S	T	U	V	W	X	Y	Z
WK27	WK28	WK29	WK30	WK31	WK32	WK33	WK34	WK35	WK36	WK37	WK38	WK39
a	b	c	d	e	f	g	h	i	j	k	l	m
WK40	WK41	WK42	WK43	WK44	WK45	WK46	WK47	WK48	WK49	WK50	WK51	WK52
n	o	p	q	r	s	t	u	v	w	x	y	z

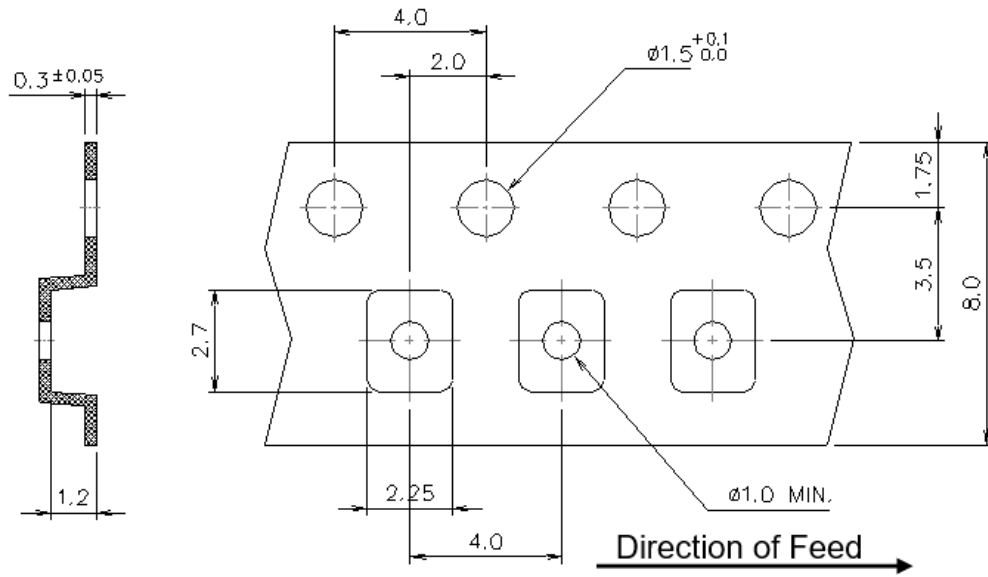
Product Code Table: (Under line With Even Year and Odd Year for Nothing)

Year						Product Code
2013	2015	2017	2019	2021	2023	□
2014	2016	2018	2020	2022	2024	□

Reel Dimensions (mm):



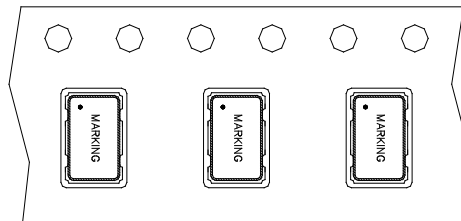
Tape Dimensions (mm):



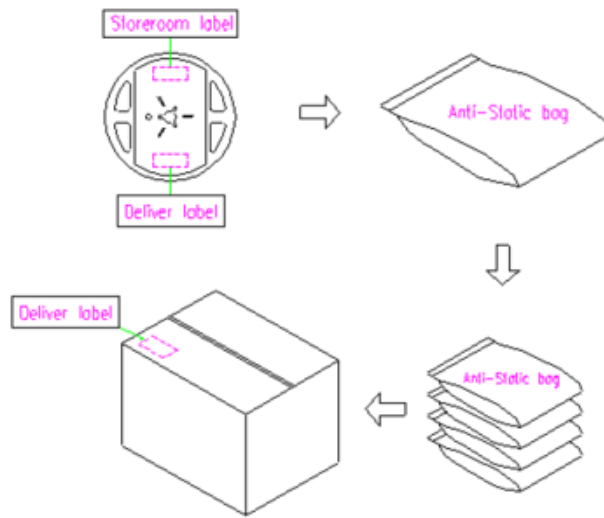
[NOTE]:

1. Unless otherwise specified tolerance on dimension ± 0.1 mm.
2. Material: conductive polystyrene with color black.
3. 10 pitch cumulative tolerance ± 0.2 mm.

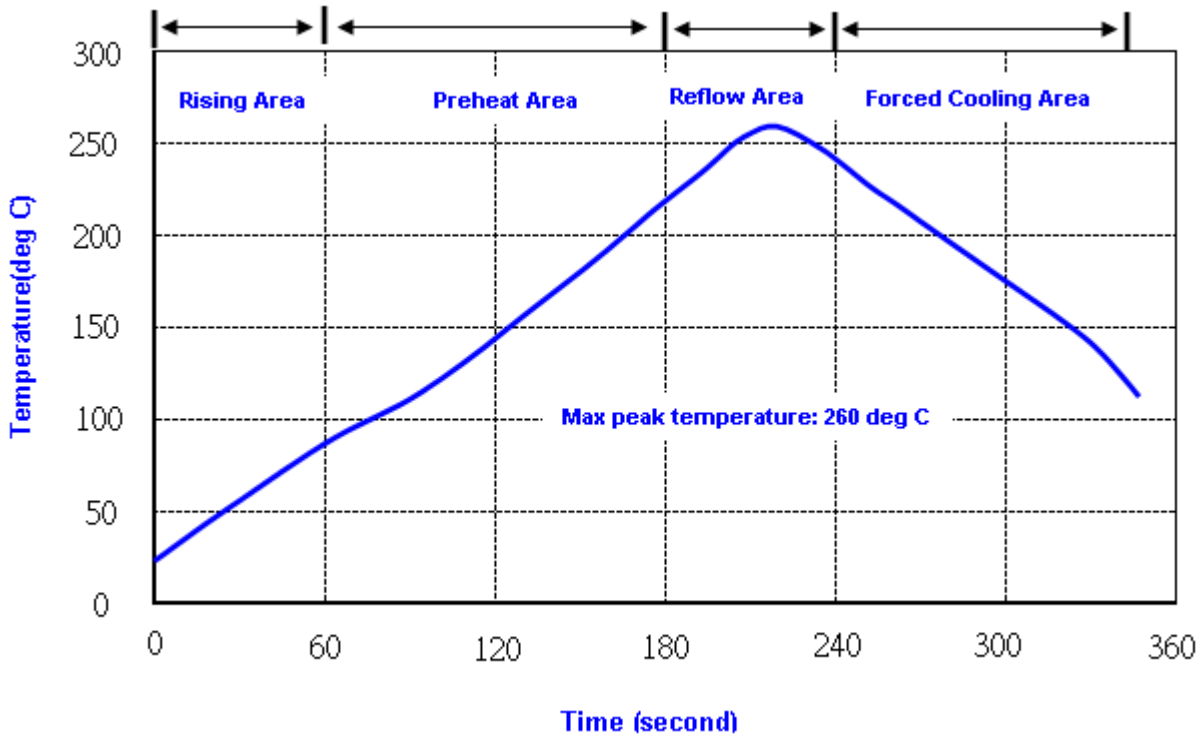
PACKING DIRECTION:



Packing Quantity/Packing:
3Kpcs per reel



Reflow Profile:



- Note:**
1. Max peak temperature: 260+/-5 deg C; Time: 10+/-2 sec
 2. Temperature: 217+/-5 deg C; Time: 90~100 sec

Reliability Specifications

Test name	Test process / method	Reference standard
Mechanical characteristics		
resistance to Soldering heat (IR reflow)	Temp./ Duration : 265°C /10sec ×2 times Total time : 4min.(IR-reflow)	EIAJED-4701 -300(301)M(II)
Vibration	Total peak amplitude : 1.5mm Vibration frequency : 10 to 2000 Hz Sweep period : 20 minute Vibration directions : 3 mutually perpendicular Duration : 2 hr / direc.	MIL-STD 202G method 204
Mechanical Shock	directions : 3 impacts per axis Acceleration : 3000g's, +20/-0 % Duration : 0.3 ms (total 18 shocks) Waveform : Half-sine	MIL-STD 202G method 213
Solderability	Solder Temperature:265±5°C Duration time: 5±0.5 seconds.	J-STD-002
Environmental characteristics		
Thermal Shock	Heat cycle conditions -40 °C (30min) ↔ 85 °C (30min) * cycle time : 10 times	MIL-STD 883G method 1010.8
Humidity test	Temperature : 85 ± 2 °C Relative humidity : 85% Duration : 96 hours	MIL-STD 202G method 103
Dry heat (Aging test)	Temperature : 125 ± 2 °C Duration : 168 hours	MIL-STD 202G method 108A
Cold resistance (Low Temp Storage)	Temperature : -40 ± 2 °C Duration : 96 hours	IEC 60068-2-1